

# RFL2N05, RFL2N06

2A, 50V and 60V, 0.95 Ohm,  
N-Channel Power MOSFETs

## Features

- 2A, 50V and 60V
- $r_{DS(ON)} = 0.95\Omega$
- SOA is Power-Dissipation Limited
- Nanosecond Switching Speeds
- Linear Transfer Characteristics
- High Input Impedance
- Majority Carrier Device
- Related Literature

## Description

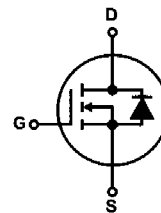
These are N-Channel enhancement mode silicon gate power field effect transistors designed for applications such as switching regulators, switching converters, motor drivers, relay drivers, and drivers for high power bipolar switching transistors requiring high speed and low gate drive power. These types can be operated directly from integrated circuits.

## Ordering Information

| PART NUMBER | PACKAGE  | BRAND   |
|-------------|----------|---------|
| RFL2N05     | TO-205AF | RFL2N05 |
| RFL2N06     | TO-205AF | RFL2N06 |

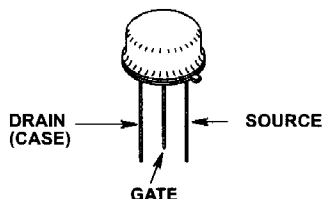
NOTE: When ordering, include the entire part number.

## Symbol

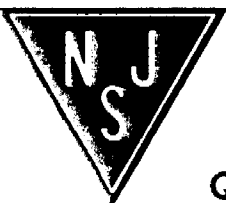


## Packaging

JEDEC TO-205AF



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**Absolute Maximum Ratings**  $T_C = 25^\circ\text{C}$ , Unless Otherwise Specified

|  | RFL2N05        | RLF2N06    | UNITS      |                     |
|--|----------------|------------|------------|---------------------|
| Drain to Source Voltage (Note 1) . . . . .                       | $V_{DSS}$      | 50         | 60         | V                   |
| Drain to Gate Voltage ( $R_{GS} = 1M\Omega$ ) (Note 1) . . . . . | $V_{DGR}$      | 50         | 60         | V                   |
| Gate to Source Voltage . . . . .                                 | $V_{GS}$       | $\pm 20$   | $\pm 20$   | V                   |
| Drain Current, RMS Continuous . . . . .                          | $I_D$          | 2          | 2          | A                   |
| Pulsed . . . . .   | $I_{DM}$       | 10         | 10         | A                   |
| Maximum Power Dissipation . . . . .                              | $P_D$          | 8.33       | 8.33       | W                   |
| Linear Derating Factor . . . . .                                 |                | 0.0667     | 0.0667     | W/ $^\circ\text{C}$ |
| Operating and Storage Temperature Range . . . . .                | $T_J, T_{STG}$ | -55 to 150 | -55 to 150 | $^\circ\text{C}$    |
| Maximum Temperature for Soldering                                |                |            |            |                     |
| Leads at 0.063in (1.6mm) from Case for 10s . . . . .             | $T_L$          | 300        | 300        | $^\circ\text{C}$    |
| Package Body for 10s, See Techbrief 334 . . . . .                | $T_{pk}$       | 260        | 260        | $^\circ\text{C}$    |

**CAUTION:** Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

**NOTE:**

- $T_J = 25^\circ\text{C}$  to  $125^\circ\text{C}$ .

**Electrical Specifications**  $T_C = 25^\circ\text{C}$ , Unless Otherwise Specified

| PARAMETER                              | SYMBOL          | TEST CONDITIONS   | MIN                                    | TYP | MAX       | UNITS              |               |
|--|-----------------|---|--|-----|-----------|--------------------|---------------|
| Drain to Source Breakdown Voltage      | $BV_{DSS}$      | $I_D = 250\mu\text{A}, V_{GS} = 0$  | RFL2N05                                | 50  | -         | -                  | V             |
|  |                 |   | RFL2N06                                | 60  | -         | -                  | V             |
| Gate to Threshold Voltage              | $V_{GS(TH)}$    | $V_{GS} = V_{DS}, I_D = 250\mu\text{A}$ , (Figure 8)  | 2                                      | -   | 4         | V                  |               |
| Zero-Gate Voltage Drain Current        | $I_{DSS}$       | $V_{DS} = 0.8 \times \text{Rated } BV_{DSS}, T_C = 25^\circ\text{C}$                                  |  | -   | -         | 1                  | $\mu\text{A}$ |
|  |                 |   | $T_C = 125^\circ\text{C}$              | -   | -         | 25                 | $\mu\text{A}$ |
| Gate to Source Leakage Current         | $I_{GSS}$       | $V_{GS} = \pm 20\text{V}, V_{DS} = 0$   | -                                      | -   | $\pm 100$ | nA                 |               |
| Drain to Source On Voltage (Note 2)    | $V_{DS(ON)}$    | $I_D = 1\text{A}, V_{GS} = 10\text{V}$  |  | -   | -         | 0.95               | V             |
|  |                 |   | $I_D = 2\text{A}, V_{GS} = 10\text{V}$ | -   | -         | 2.0                | V             |
|  |                 |   | $I_D = 4\text{A}, V_{GS} = 15\text{V}$ | -   | -         | 4.8                | V             |
| Drain to Source On Resistance (Note 2) | $r_{DS(ON)}$    | $I_D = 1\text{A}, V_{GS} = 10\text{V}$ , (Figures 6, 7)   | -                                      | -   | 0.95      | $\Omega$           |               |
| Forward Transconductance (Note 2)      | $g_{fs}$        | $I_D = 1\text{A}, V_{DS} = 10\text{V}$ , (Figure 10)  | 400                                    | -   | -         | S                  |               |
| Turn-On Delay Time                     | $t_{d(ON)}$     | $I_D = 1\text{A}, V_{DD} = 30\text{V}, R_{GS} = 50\Omega, V_{GS} = 10\text{V}$ , (Figures 11, 12, 13) | -                                      | 6   | 15        | ns                 |               |
| Rise Time                              | $t_r$           |   | -                                      | 14  | 30        | ns                 |               |
| Turn-Off Delay Time                    | $t_{d(OFF)}$    |   | -                                      | 16  | 30        | ns                 |               |
| Fall Time                              | $t_f$           |   | -                                      | 30  | 50        | ns                 |               |
| Input Capacitance                      | $C_{ISS}$       | $V_{GS} = 0\text{V}, V_{DS} = 25\text{V}, f = 1\text{MHz}$ , (Figure 9)                               | -                                      | -   | 200       | pF                 |               |
| Output Capacitance                     | $C_{OSS}$       |   | -                                      | -   | 85        | pF                 |               |
| Reverse-Transfer Capacitance           | $C_{RSS}$       |   | -                                      | -   | 30        | pF                 |               |
| Thermal Resistance Junction to Case    | $R_{\theta JC}$ |   | -                                      | -   | 15        | $^\circ\text{C/W}$ |               |

**Source to Drain Diode Specifications**

| PARAMETER                              | SYMBOL   | TEST CONDITIONS   | MIN | TYP | MAX | UNITS |
|--|----------|---|-----|-----|-----|-------|
| Source to Drain Diode Voltage (Note 2) | $V_{SD}$ | $I_{SD} = 1\text{A}$                                      | -   | -   | 1.4 | V     |
| Diode Reverse Recovery Time            | $t_{rr}$ | $I_{SD} = 2\text{A}, dI_{SD}/dt = 50\text{A}/\mu\text{s}$ | -   | 100 | -   | ns    |

**NOTE:**

- Pulse test: pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .